

Amtech Systems to Announce First Quarter Fiscal 2010 Financial Results on February 9, 2010

TEMPE, Ariz.--(BUSINESS WIRE)-- Amtech Systems, Inc. (NASDAQ:ASYS), a global supplier of production and automation systems and related supplies for the manufacture of solar cells, semiconductors, and silicon wafers, today reported that it will announce its first quarter fiscal 2010 financial results after the close of regular market trading on Tuesday, February 9, 2010. The Company will report results in a news release issued immediately following the close of the market on February 9, 2010, followed by a conference call to discuss the results starting at 2:00 p.m. Pacific Time (5:00 p.m. ET).

What: Amtech first quarter fiscal 2010 financial results conference call

When: Tuesday, February 9th at 2:00 p.m. Pacific Time (5:00 p.m. ET)

A live and archived web cast of the conference call can be accessed

Webcast: from the investors section of Amtech's website at

www.amtechsystems.com.

Dial in: To access the live conference call, dial (877) 941-1465 and request

the "Amtech" call.

An audio replay of the conference call can be accessed at (800)

Replay: 406-7325. The replay will be available starting approximately two

hours after the call and remain in effect for one week. The required

pass code is 4207585#.

About Amtech Systems, Inc.

Amtech Systems, Inc. manufactures capital equipment, including silicon wafer handling automation, thermal processing equipment and related consumables used in fabricating solar cells and semiconductor devices. Semiconductors, or semiconductor chips, are fabricated on silicon wafer substrates, sliced from ingots, and are part of the circuitry, or electronic components, of many products including solar cells, computers, telecommunications devices, automotive products, consumer goods, and industrial automation and control systems. The Company's wafer handling, thermal processing and consumable products currently address the diffusion, oxidation, deposition, PECVD, and PSG removal steps used in the fabrication of solar cells, semiconductors, MEMS and the polishing of newly sliced silicon wafers.